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A. Patent Application No.(s)	B. Patent No.(s)
11/002 212	
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In consideration of One Dollar and other good and valuable consideration, of which receipt is acknowledged, I Jue PENG of The Hong Kong Polytechnic University, sell and assign to The Hong Kong Polytechnic University, a Hong Kong entity, the entire right, title, and interest in and to the invention titled Fabrication of Piezoelectric Single ... (IP-409A) invented by me as described in the application for United States patent executed by me concurrently herewith, and any and all applications for patent and patents in any and all countries, including all divisions, continuations, reissues, and extensions thereof and all rights of priority resulting from the filing of said United States application and authorize and request any official whose duty it is to issue patents to issue any patent on said improvements or resulting therefrom to said The Hong Kong Polytechnic University, or its successors, assigns, or nominees and agree that on request and without further consideration, but at the expense of The Hong Kong Polytechnic University, I will communicate to the University or its representatives or nominees any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally aid said University, its successors, assigns, and nominees to obtain and enforce proper patent protection for said invention in all countries.

tent we this 16 day of Aug 2007

In consideration of One Dollar and other good and valuable consideration, of which receipt is acknowledged, I Chen CHAO of The Hong Kong Polytechnic University, sell and assign to The Hong Kong Polytechnic University, a Hong Kong entity, the entire right, title, and interest in and to the invention titled Fabrucation of Piezoelectric Single (IP 409A) invented by me as described in the application for United States patent executed by me concurrently herewith, and any and all applications for patent and patents in any and all countries, including all divisions, continuations, reissues, and extensions thereof and all rights of priority resulting from the filing of said United States application and authorize and request any official whose duty it is to issue patents to issue any patent on said improvements or resulting therefrom to said The Hong Kong Polytechnic University, or its successors, assigns, or nominees and agree that on request and without further consideration, but at the expense of The Hong Kong Polytechnic University, I will communicate to the University or its representatives or nominees any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally aid said University, its successors, assigns, and nominees to obtain and enforce proper patent protection for said invention in all countries.

In consideration of One Dollar and other good and valuable consideration, of which receipt is acknowledged, I Ti Yan DAI Kong Polytechnic University, sell and assign to The Hong Kong Polytechnic University, a Hong Kong entity, the entire right, title, and interest in and to the invention titled <u>Fabrication of Piezoelectric Single</u>... (IP-409A) invented by me as described in the application for United States patent executed by me concurrently herewith, and any and all applications for patent and patents in any and all countries, including all divisions, continuations, reissues, and extensions thereof and all rights of priority resulting from the filing of said United States application and authorize and request any official whose duty it is to issue patents to issue any patent on said improvements or resulting therefrom to said The Hong Kong Polytechnic University, or its successors, assigns, or nominees and agree that on request and without further consideration, but at the expense of The Hong Kong Polytechnic University, I will communicate to the University or its representatives or nominees any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally aid said University, its successors, assigns, and nominees to obtain and enforce proper patent protection for said invention in all countries.

74. De this 16 day of Aug. 2007

In consideration of One Dollar and other good and valuable consideration, of which receipt is acknowledged, I Helen LW CHAN of The Hong Kong Polytechnic University, sell and assign to The Hong Kong Polytechnic University, a Hong Kong entity, the entire right, title, and interest in and to the invention titled Fabrication of Piezoelectric Single (IP:409A) invented by me as described in the application for United States patent executed by me concurrently herewith, and any and all applications for patent and patents in any and all countries, including all divisions, continuations, reissues, and extensions thereof and all rights of priority resulting from the filing of said United States application and authorize and request any official whose duty it is to issue patents to issue any patent on said improvements or resulting therefrom to said The Hong Kong Polytechnic University, or its successors, assigns, or nominees and agree that on request and without further consideration, but at the expense of The Hong Kong Polytechnic University, I will communicate to the University or its representatives or nominees any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths and generally aid said University, its successors, assigns, and nominees to obtain and enforce proper patent protection for said invention in all countries.

PATENT REEL: 021832 FRAME: 0318

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